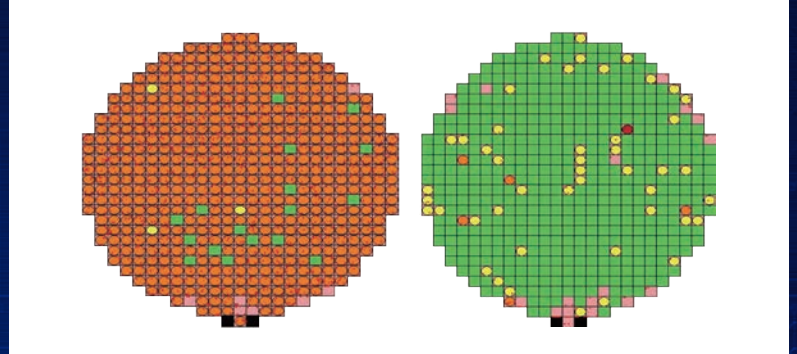


CO2 Wafer Cleaner

DANDI 3100



Environment Friendly ! No chemical ! No water !

- Dry cleaning of wafer surface using IMT CO2 MicrojetTM
- Simple & Fast cleaning process
- Safe cleaning without any pattern damage
- Particle removal after HBM wafer dicing
- Contamination removal during wafer level packaging



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CO2 Cleaning Applications

